## High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch


#### Abstract

General Description The MAX2039 high-linearity passive upconverter or downconverter mixer is designed to provide 7.3 dB NF and a 7.1 dB conversion loss for an RF frequency range of 1700 MHz to 2200 MHz to support UMTS/WCDMA, DCS, and PCS base-station transmitter or receiver applications. The IIP3 is typically +34.5 dBm and +33.5 dBm for downconversion and upconversion operation, respectively. With an LO frequency range of 1500 MHz to 2000 MHz , this particular mixer is ideal for low-side LO injection architectures. (For a pin-to-pincompatible mixer meant for high-side LO injection, contact the factory.) In addition to offering excellent linearity and noise performance, the MAX2039 also yields a high level of component integration. This device includes a double-balanced passive mixer core, a dual-input LO selectable switch, and an LO buffer. On-chip baluns are also integrated to allow for a single-ended RF input for downconversion (or RF output for upconversion), and single-ended LO inputs. The MAX2039 requires a nominal LO drive of 0 dBm , and supply current is guaranteed to be below 135 mA . The MAX2039 is pin compatible with the MAX2031 815 MHz to 995 MHz mixer, making this family of passive upconverters and downconverters ideal for applications where a common PC board layout is used for both frequency bands. The MAX2039 is available in a compact 20-pin thin QFN package ( $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ ) with an exposed paddle. Electrical performance is guaranteed over the extended $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range.


UMTS/WCDMA Base Stations
DCS1800/PCS1900 EDGE Base Stations
cdmaOneTM and cdma2000® Base Stations
PHS/PAS Base Stations
Predistortion Receivers
Fixed Broadband Wireless Access
Wireless Local Loop
Private Mobile Radio
Military Systems
Microwave Links
Digital and Spread-Spectrum Communication
Systems
cdmaOne is a trademark of CDMA Development Group.
cdmazooo is a registered trademark of Telecommunications
Industry Association.

Features

- 1700 MHz to 2200 MHz RF Frequency Range
- 1500MHz to 2000MHz LO Frequency Range
- 1900MHz to 2400 MHz LO Frequency Range (Contact Factory)
- DC to 350 MHz IF Frequency Range
- 7.1dB Conversion Loss
- +34.5dBm Input IP3 (Downconversion)
- +24.4dBm Input 1dB Compression Point
- 7.3dB Noise Figure
- Integrated LO Buffer
- Integrated RF and LO Baluns
- Low -3dBm to +3dBm LO Drive
- Built-In SPDT LO Switch with 45dB LO1 to LO2 Isolation and 50ns Switching Time
- Pin Compatible with the MAX2031 815MHz to 995MHz Mixer
- External Current-Setting Resistor Provides Option for Operating Mixer in Reduced-Power/ReducedPerformance Mode
- Lead-Free Package Available

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE | PKG CODE |
| :---: | :---: | :---: | :---: |
| MAX2039ETP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20 Thin QFN-EP* <br> ( $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ ) bulk | T2055-3 |
| MAX2039ETP-T | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20 Thin QFN-EP* <br> ( $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ ) T/R | T2055-3 |
| MAX2039ETP+D | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20 Thin QFN-EP* <br> ( $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ ) <br> lead-free <br> bulk | T2055-3 |
| MAX2039ETP+TD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20 Thin QFN-EP* <br> ( $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ ) <br> lead-free <br> T/R | T2055-3 |

* EP = Exposed paddle.
$+=$ Lead free.
D = Dry pack.
Pin Configuration and Typical Application Circuit appear at end of data sheet.


## AUAXIVV

 Maxim Integrated ProductsFor pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

# High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch 

## ABSOLUTE MAXIMUM RATINGS

| V | 5V |
| :---: | :---: |
| TAP, LOBIAS, LOSEL to GND | -0.3V to (VCC + 0.3V) |
| LO1, LO2, IF+, IF- to GND | -0.3V to +0.3V |
| RF, IF, LO1, LO2 Input Power | +15dBm |
| RF (RF is DC shorted to GND | alun) ................ 50 mA |
| Continuous Power Dissipation |  |
| 20-Pin QFN-EP (derate 20m | $\left.\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}\right) \ldots . .2 .2$ |


| $\theta_{\text {JA }}$ | $+33^{\circ} \mathrm{C} / \mathrm{W}$ |
| :---: | :---: |
| ӨJC ....................................................................... $+8^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| Operating Temperature Range (Note A) .... $\mathrm{T}^{\text {C }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |
| Junction Temperature | + $150^{\circ} \mathrm{C}$ |
| Storage Temperature Range | -65 ${ }^{\circ} \mathrm{C}$ to $+165^{\circ} \mathrm{C}$ |
| Lead Temperature (soldering, 10s) | $+300^{\circ} \mathrm{C}$ |

Note A: $T_{C}$ is the temperature on the exposed paddle of the package.
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

(MAX2039 Typical Application Circuit, VCC $=+4.75 \mathrm{~V}$ to +5.25 V , $\mathrm{TC}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, no RF signals applied, IF+ and IF- DC grounded through a transformer. Typical values are at $\mathrm{V} C \mathrm{C}=+5 \mathrm{~V}, \mathrm{TC}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX |
| :--- | :---: | :---: | ---: | :---: | :---: |
| UNITS |  |  |  |  |  |
| Supply Voltage | $V_{\text {CC }}$ |  | 4.75 | 5.00 | 5.25 |
| Supply Current | ICC |  |  | 104 | 135 |
| LO_SEL Input Logic Low | $\mathrm{V}_{\text {IL }}$ |  |  | mA |  |
| LO_SEL Input Logic High | $\mathrm{V}_{\text {IH }}$ |  | 2 | 0.8 | V |

## AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION)

(MAX2039 Typical Application Circuit, $\mathrm{VCC}=+4.75 \mathrm{~V}$ to $+5.25 \mathrm{~V}, \mathrm{~T} \mathrm{C}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, RF and LO ports are driven from $50 \Omega$ sources, $P_{\text {LO }}=-3 \mathrm{dBm}$ to $+3 \mathrm{dBm}, \mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=1700 \mathrm{MHz}$ to $2200 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1500 \mathrm{MHz}$ to $2000 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{f}_{\mathrm{RF}}>\mathrm{f}_{\mathrm{LO}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$, $\mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{PLO}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1700 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{T}_{\mathrm{C}}=$ $+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Notes 1, 2)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RF Frequency Range | fRF | (Note 3) | 1700 |  | 2200 | MHz |
| LO Frequency Range | flo | (Note 3) | 1500 |  | 2000 | MHz |
|  |  | (Contact factory) | 1900 |  | 2400 |  |
| IF Frequency Range | fiF | External IF transformer dependent | DC |  | 350 | MHz |
| Conversion Loss | LC | $\mathrm{PRF}_{\text {R }}<+2 \mathrm{dBm}$ |  | 7.1 |  | dB |
| Loss Variation Over Temperature |  | $\mathrm{T}^{\mathrm{C}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 0.0075 |  | $\mathrm{dB} /{ }^{\circ} \mathrm{C}$ |
| Input Compression Point | $\mathrm{P}_{1 \mathrm{~dB}}$ | (Note 4) |  | 24.4 |  | dBm |
| Input Third-Order Intercept Point | IIP3 | $\begin{aligned} & \hline \text { Two tones: } \\ & \text { fRF1 }=2000 \mathrm{MHz}, \\ & \text { fRF2 }=2001 \mathrm{MHz}, \\ & \text { PRF }=+5 \mathrm{dBm} / \text { tone }, \\ & \text { fLO }=1800 \mathrm{MHz}, \\ & \text { PLO }=0 \mathrm{dBm} \\ & \hline \end{aligned}$ | 31 | 34.5 |  | dBm |
| Input IP3 Variation Over Temperature |  | T $\mathrm{C}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | $\pm 0.75$ |  | dB |
| Noise Figure | NF | Single sideband |  | 7.3 |  | dB |

## High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch

## AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION) (continued)

(MAX2039 Typical Application Circuit, $\mathrm{V} C \mathrm{C}=+4.75 \mathrm{~V}$ to +5.25 V , $\mathrm{TC}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, RF and LO ports are driven from $50 \Omega$ sources, $P_{L O}=-3 \mathrm{dBm}$ to $+3 \mathrm{dBm}, \mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=1700 \mathrm{MHz}$ to $2200 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1500 \mathrm{MHz}$ to $2000 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{f}_{\mathrm{RF}}>\mathrm{f}_{\mathrm{LO}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{LO}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1700 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{T}_{\mathrm{C}}=$ $+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Notes 1, 2)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Noise Figure Under-Blocking |  | $\begin{aligned} & \text { PRF }=5 \mathrm{dBm}, \mathrm{fRF}=2000 \mathrm{MHz}, \mathrm{fLO}= \\ & 1810 \mathrm{MHz}, \mathrm{f}_{\text {block }}=2100 \mathrm{MHz} \\ & (\text { Note } 5) \end{aligned}$ |  | 19 |  | dB |
| LO Drive |  |  | -3 |  | +3 | dBm |
| Spurious Response at IF | $2 \times 2$ | $\begin{aligned} & \text { 2RF - 2LO, } \\ & \text { PRF }=0 \mathrm{dBm} \end{aligned}$ |  | 73 |  | dBc |
|  | $3 \times 3$ | $\begin{aligned} & 3 \mathrm{RF}-3 \mathrm{LO}, \\ & \text { PRF }=0 \mathrm{dBm} \end{aligned}$ |  | 72 |  |  |
| LO1 to LO2 Isolation (Note 1) |  | LO2 selected, 1500MHz < fLO < 1700MHz | 40 | 52 |  | dB |
|  |  | LO1 selected, 1500 MHz < fLO < 1700MHz | 40 | 45 |  |  |
| Maximum LO Leakage at RF Port |  | PLO $=+3 \mathrm{dBm}$ |  | -18 |  | dBm |
| Maximum LO Leakage at IF Port |  | PLO $=+3 \mathrm{dBm}$ |  | -27.5 |  | dBm |
| Minimum RF-to-IF Isolation |  |  |  | 35 |  | dB |
| LO Switching Time |  | $50 \%$ of LOSEL to IF settled to within $2^{\circ}$ |  | 50 |  | ns |
| RF Port Return Loss |  |  |  | 18 |  | dB |
| LO Port Return Loss |  | LO port selected, LO and IF terminated |  | 16 |  | dB |
|  |  | LO port unselected, LO and IF terminated |  | 26 |  |  |
| IF Port Return Loss |  | LO driven at 0 dBm , RF terminated into $50 \Omega$ |  | 20 |  | dB |

# High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch 

## AC ELECTRICAL CHARACTERISTICS (UPCONVERTER OPERATION)

(MAX2039 Typical Application Circuit, $\mathrm{VCC}=+4.75 \mathrm{~V}$ to $+5.25 \mathrm{~V}, \mathrm{TC}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}, \mathrm{PLO}=-3 \mathrm{dBm}$ to +3 dBm , $\mathrm{PIF}=0 \mathrm{dBm}$, $\mathrm{fRF}=$ 1700 MHz to $2200 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1500 \mathrm{MHz}$ to $2000 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, f_{R F}=\mathrm{f}_{\mathrm{LO}}+\mathrm{f}_{\mathrm{IF}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}$ $=+5 \mathrm{~V}, \mathrm{P}_{\mathrm{IF}}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{LO}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1700 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Note 2)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Compression Point | $\mathrm{P}_{1 \mathrm{~dB}}$ | (Note 4) |  | 24.4 |  | dBm |
| Input Third-Order Intercept Point | IIP3 | Two tones: $\begin{aligned} & \mathrm{f}_{\mathrm{fIF} 1}=200 \mathrm{MHz}, \\ & \mathrm{fIF}=210 \mathrm{MHz}, \\ & \text { PIF }=+5 \mathrm{dBm} / \text { tone }, \\ & \mathrm{fLO}=1940 \mathrm{MHz}, \\ & \text { PLO }=0 \mathrm{dBm} \end{aligned}$ | 29.5 | 33.5 |  | dBm |
| LO $\pm 2 \mathrm{IF}$ Spur |  | LO-2IF |  | 67 |  | dBc |
|  |  | LO + 2IF |  | 63 |  |  |
| LO $\pm 3$ IF Spur |  | LO-3IF |  | 72 |  | dBc |
|  |  | LO + 3IF |  | 76 |  |  |
| Output Noise Floor |  | Pout $=0 \mathrm{dBm}$ |  | -160 |  | $\begin{gathered} \mathrm{dBm} / \\ \mathrm{Hz} \end{gathered}$ |

Note 1: Guaranteed by design and characterization.
Note 2: All limits include external component losses. Output measurements taken at IF port for downconverter and RF port for upconverter from the Typical Application Circuit.
Note 3: Operation outside this range is possible, but with degraded performance of some parameters.
Note 4: Compression point characterized. It is advisable not to continuously operate the mixer RF or IF input above +15 dBm . Note 5: Measured with external LO source noise filtered such that the noise floor is $-174 \mathrm{dBm} / \mathrm{Hz}$. This specification reflects the effects of all SNR degradations in the mixer, including the LO noise as defined in Maxim Application Note 2021.

## High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch

## Typical Operating Characteristics

(MAX2039 Typical Application Circuit, $\mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{PLO}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}>\mathrm{f}_{\mathrm{LO}}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{R}_{1}=549 \Omega$, unless otherwise noted.)

## Downconverter Curves





CONVERSION LOSS vs. RF FREQUENCY





CONVERSION LOSS vs. RF FREQUENCY


NOISE FIGURE vs. RF FREQUENCY


# High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch 

(MAX2039 Typical Application Circuit, $\mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{PLO}_{\mathrm{LO}}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}>\mathrm{f}_{\mathrm{LO}}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{R}_{1}=549 \Omega$, unless otherwise noted.)




## Downconverter Curves






INPUT P1db vs. RF FREQUENCY


## High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch

## Typical Operating Characteristics (continued)

(MAX2039 Typical Application Circuit, $\mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{PLO}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}>\mathrm{f}_{\mathrm{LO}}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{R}_{1}=549 \Omega$, unless otherwise noted.)


# High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch 

## Typical Operating Characteristics (continued)

(MAX2039 Typical Application Circuit, $\mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{PLO}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{RF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}>\mathrm{f}_{\mathrm{LO}}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{R}_{1}=549 \Omega$, unless otherwise noted.)


## High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch

$\overline{(M A X 2039 ~ T y p i c a l ~ A p p l i c a t i o n ~ C i r c u i t, ~} \mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{PLO}_{\mathrm{LO}}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{IF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=\mathrm{f}_{\mathrm{LO}}+\mathrm{f}_{\mathrm{IF}}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{R}_{1}=549 \Omega$, unless oth erwise noted.)




## Upconverter Curves



INPUT IP3 vs. RF FREQUENCY


LO + 2IF REJECTION vs. RF FREQUENCY


CONVERSION LOSS vs. RF FREQUENCY


INPUT IP3 vs. RF FREQUENCY


LO + 2IF REJECTION vs. RF FREQUENCY


## High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch

(MAX2039 Typical Application Circuit, $\mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{P}_{\mathrm{LO}}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{IF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=\mathrm{f}_{\mathrm{LO}}+\mathrm{f}_{\mathrm{IF}}, \mathrm{f}_{\mathrm{IF}}=200 \mathrm{MHz}, \mathrm{R}_{1}=549 \Omega$, unless otherwise noted.)


## High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch

## Typical Operating Characteristics (continued)

(MAX2039 Typical Application Circuit, $\mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{PLO}=0 \mathrm{dBm}, \mathrm{P}_{\mathrm{IF}}=0 \mathrm{dBm}, \mathrm{f}_{\mathrm{RF}}=\mathrm{f}_{\mathrm{LO}}+\mathrm{f}_{\mathrm{IF}}, \mathrm{f}_{\mathrm{f}}=200 \mathrm{MHz}, \mathrm{R}_{1}=549 \Omega$, unless otherwise noted.)

Upconverter Curves


If LEAKAGE AT RF vs. LO FREQUENCY



IF LEAKAGE AT RF vs. LO FREQuENCY


LO LEAKAGE AT RF PORT vs. RF FREQUENCY


IF LEAKAGE AT RF vs. RF FREQUENCY


# High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch 

Pin Description

| PIN | NAME | FUNCTION |
| :---: | :---: | :--- |
| $1,6,8,14$ | VCC | Power-Supply Connection. Bypass each VCC pin to GND with capacitors as shown in the Typical <br> Application Circuit. |
| 2 | RF | Single-Ended $50 \Omega$ RF Input/Output. This port is internally matched and DC shorted to GND through a <br> balun. |
| 3 | TAP | Center Tap of the Internal RF Balun. Bypass to GND with capacitors close to the IC, as shown in the <br> Typical Application Circuit. |
| $4,5,10,12$, <br> $13,16,17$, <br> 20 | GND | Ground |
| 7 | LOBIAS | Bias Resistor for Internal LO Buffer. Connect a 549 $1 \%$ resistor from LOBIAS to the power supply. |
| 9 | LOSEL | Local Oscillator Select. Logic control input for selecting LO1 or LO2. |
| 11 | LO1 | Local Oscillator Input 1. Drive LOSEL low to select LO1. |
| 15 | LO2 | Local Oscillator Input 2. Drive LOSEL high to select LO2. |
| 18,19 | IF-, IF+ | Differential IF Input/Outputs |
| EP | GND | Exposed Ground Paddle. Solder the exposed paddle to the ground plane using multiple vias. |

## Detailed Description

The MAX2039 can operate either as a downconverter or an upconverter mixer that provides 7.1 dB of conversion loss with a typical 7.3 dB noise figure. IIP3 is +33.5 dBm for upconversion and +34.5 dBm for downconversion. The integrated baluns and matching circuitry allow for $50 \Omega$ single-ended interfaces to the RF port and two LO ports. The RF port can be used as an input for downconversion or an output for upconversion. A single-pole, double-throw (SPDT) switch provides 50 ns switching time between the two LO inputs with 45 dB of LO-to-LO isolation. Furthermore, the integrated LO buffer provides a high drive level to the mixer core, reducing the LO drive required at the MAX2039's inputs to a range of -3 dBm to +3 dBm . The IF port incorporates a differential output for downconversion, which is ideal for providing enhanced IIP2 performance. For upconversion, the IF port is a differential input.
Specifications are guaranteed over broad frequency ranges to allow for use in UMTS, cdma2000, and 2G/2.5G/3G DCS1800, and PCS1900 base stations. The MAX2039 is specified to operate over an RF frequency range of 1700 MHz to 2200 MHz , an LO frequency range of 1500 MHz to 2000 MHz , and an IF frequency range of DC to 350 MHz . Operation beyond these ranges is possible; see the Typical Operating Characteristics for additional details.

This device can operate in high-side LO injection applications with an extended LO range, but performance degrades as flo continues to increase. See the Typical Operating Characteristics for measurements taken with flo up to 2200 MHz . For a device with better high-side LO injection performance, contact the factory.

RF Port and Balun
For using the MAX2039 as a downconverter, the RF input is internally matched to $50 \Omega$, requiring no external matching components. A DC-blocking capacitor is required since the input is internally DC shorted to ground through the on-chip balun. The RF return loss is typically 18 dB over the entire 1700 MHz to 2200 MHz RF frequency range. For upconverter operation, the RF port is a singleended output similarly matched to $50 \Omega$.

## LO Inputs, Buffer, and Balun

 The MAX2039 can be used for either high-side or lowside injection applications with a 1500 MHz to 2000 MHz LO frequency range. For a device with a 1900 MHz to 2400 MHz LO frequency range, contact the factory. As an added feature, the MAX2039 includes an internal LO SPDT switch that can be used for frequency-hopping applications. The switch selects one of the two singleended LO ports, allowing the external oscillator to settle on a particular frequency before it is switched in. LO switching time is typically less than 50 ns , which is more than adequate for virtually all GSM applications.
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If frequency hopping is not employed, set the switch to either of the LO inputs. The switch is controlled by a digital input (LOSEL): logic high selects LO2, logic low selects LO1. In order to avoid damage to the part, voltage MUST be applied to VCC before digital logic is applied to LOSEL (see the Absolute Maximum Ratings). LO1 and LO2 inputs are internally matched to $50 \Omega$, requiring only a 22 pF DC-blocking capacitor.
A two-stage internal LO buffer allows a wide-input power range for the LO drive. All guaranteed specifications are for an LO signal power from -3 dBm to +3 dBm . The on-chip low-loss balun, along with an LO buffer, drives the double-balanced mixer. All interfacing and matching components from the LO inputs to the IF outputs are integrated on chip.

High-Linearity Mixer The core of the MAX2039 is a double-balanced, highperformance passive mixer. Exceptional linearity is provided by the large LO swing from the on-chip LO buffer.

Differential IF
The MAX2039 mixer has an IF frequency range of DC to 350 MHz . Note that these differential ports are ideal for providing enhanced IIP2 performance. Single-ended IF applications require a $1: 1$ balun to transform the $50 \Omega$ differential IF impedance to a $50 \Omega$ single-ended system. After the balun, the IF return loss is better than 15 dB . The differential IF is used as an input port for upconverter operation. The user can use a differential IF amplifier following the mixer but a DC block is required on both IF pins. In this configuration, the IF+ and IF- pins need to be returned to ground through a high resistance (about $1 k \Omega$ ). This ground return can also be accomplished by grounding the RF TAP (pin 3) and AC-coupling the IF+ and IF-ports (pins 19 and 18). uation, an external low-loss 1:1 (impedance ratio) balun

Table 1. Component List Referring to the Typical Application Circuit

| COMPONENT | VALUE | DESCRIPTION |
| :---: | :---: | :--- |
| C1 | 4 pF | Microwave capacitor (0603) |
| C4 | 10 pF | Microwave capacitor (0603) |
| C2, C6, C7, C8, <br> C10, C12 | $22 p F$ | Microwave capacitors (0603) |
| C3, C5, C9, C11 | $0.01 \mu \mathrm{~F}$ | Microwave capacitors (0603) |
| R1 | $549 \Omega$ | $\pm 1 \%$ resistor (0603) |
| T1 | $1: 1$ Balun | IF balun with DC grounded <br> ports |
| U1 | MAX2039 | Maxim IC |

transforms this impedance to a $50 \Omega$ single-ended output (see the Typical Application Circuit).

## Bias Resistor

Bias current for the LO buffer is optimized by fine tuning resistor R1. If reduced current is required at the expense of performance, contact the factory for details. If the $\pm 1 \%$ bias resistor values are not readily available, substitute standard $\pm 5 \%$ values.

## Layout Considerations

A properly designed PC board is an essential part of any RF/microwave circuit. Keep RF signal lines as short as possible to reduce losses, radiation, and inductance. For the best performance, route the ground pin traces directly to the exposed pad under the package. The PC board exposed pad MUST be connected to the ground plane of the PC board. It is suggested that multiple vias be used to connect this pad to the lower-level ground planes. This method provides a good RF/thermal conduction path for the device. Solder the exposed

## Applications Information

## Input and Output Matching

The RF and LO inputs are internally matched to $50 \Omega$. No matching components are required. Return loss at the RF port is typically 18 dB over the entire input range ( 1700 MHz to 2200 MHz ) and return loss at the LO ports is typically $16 \mathrm{~dB}(1500 \mathrm{MHz}$ to 2000 MHz ). RF and LO inputs require only DC-blocking capacitors for interfacing.
The IF output impedance is $50 \Omega$ (differential). For evalpad on the bottom of the device package to the PC board. The MAX2039 Evaluation Kit can be used as a reference for board layout. Gerber files are available upon request at www.maxim-ic.com.

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Exposed Pad RF/Thermal Considerations
The EP of the MAX2039's 20-pin thin QFN-EP package provides a low thermal-resistance path to the die. It is important that the PC board on which the MAX2039 is mounted be designed to conduct heat from the EP. In addition, provide the EP with a low-inductance path to electrical ground. The EP MUST be soldered to a ground plane on the PC board, either directly or through an array of plated via holes.
$\qquad$
TRANSISTOR COUNT: 1212
PROCESS: SiGe BiCMOS

High-Linearity, 1700MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch

Pin Configuration


# High-Linearity, 1700 MHz to 2200MHz Upconversion/ Downconversion Mixer with LO Buffer/Switch 

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



1. DiMENSINNING \& TQLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL DIMENSIDNS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES
3. $N$ IS THE TOTAL NUMBER OF TERMINALS.
THE TERMINAL 1 IDENTIFIER AND TERMINAL NLMBERING CONVENTION SHALL CONFIRN TO JESD $95-1$ SPP-012. DETAILS OF TERMINAL *1 IDENTIFIER ARE
OPTICNAL, BUT MUST BE LICATED WITHIN THE ZONE INDICATED. THE TERMINAL \#1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.

| EXPISED PAD Vartations |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PKG CODES | D2 |  |  | E2 |  |  |
|  | MIN. | NOM. | max. | MIN. | NOM. | max. |
| T1655-2 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T1655-3 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T1655N-1 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T2055-3 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T2055-4 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T2055-5 | 3.15 | 3.25 | 3.3 | 3.15 | 3.25 | 3.35 |
| T20551N-5 | 3.15 | 3.5 | 3.35 | 3.15 | 3.25 | 3.35 |
| T2855-3 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.35 |
| T2855 | 2.60 | 2.70 | 2.80 | 2.60 | 2.7 | 2.80 |
| 2855 | 2.60 | 2.70 | 2.80 | 2.60 | 2.70 | 2.80 |
| T2855-6 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.35 |
| T2855-7 | 2.60 | 2.70 | 2.80 | 2.60 | 2.70 | 2.80 |
| T2855-8 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.35 |
| T2853N-1 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.35 |
| T3255-3 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| тз255-4 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T3255M-4 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T3е55-5 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.2 |
| T3255N-1 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 |
| T4055-1 | 3.40 | 3.50 | 3.60 | 3.40 | 3.50 | 3.6 |
| T4055-2 | 3.40 | 3.50 | 3.60 | 3.40 | 3.50 | 3.60 |
| T4055MN-1 | 3.40 | 3.50 | 3.60 | 3.4 | 3.50 | 3.60 |

25. DIMENSIIN 1 APPLIES TD METALLIZED TER
26. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY,
27. DEPOPULATIIN IS POSSIBLE IN A SYMMETRICAL FASHIIN.
C. CIPLANARITY APPLIES TO THE EXPOSED FEAT SINK SLUG AS VELL AS THE TERMINALS.
T2855-3. T2855-6, T4055-1 AND T4055-2.
OA VARPAGE SHALL NOT EXCEED 0.10 mm .
28. MARKING IS FDR PACKAGE ORIENTATIDN REFERENCE DNLY.
29. NLMBER OF LEADS SHOWN ARE FOR REFERENCE DNLY
30. LEAD CENTERLINES TO BE AT TRUE PDSITIIN AS DEFINED BY BASIC DIMENSIIN ' $e^{\prime}$ ', $\pm 0.05$.
31. ALL DIMENSIONS APPLY TO BOTH LEADED AND PbFREE PARTS.
11) RALLAS /VIAXI/VI
-DRAWING NOT TO SCALE-

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.


[^0]:    ## Power-Supply Bypassing

    Proper voltage-supply bypassing is essential for highfrequency circuit stability. Bypass each VCC pin and
    TAP with the capacitors shown in the Typical frequency circuit stability. Bypass each VCC pin and
    TAP with the capacitors shown in the Typical Application Circuit; see Table 1. Place the TAP bypass capacitor to ground within 100 mils of the TAP pin.

